

FEATURES:

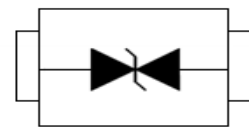
- ✧ Protects one bi-directional I/O line
- ✧ Low clamping voltage
- ✧ Low operating voltage: 24V
- ✧ ROHS compliant



SOD-323

MAIN APPLICATIONS

- ✧ Cell Phone Handsets and Accessories
- ✧ Personal Digital Assistants (PDA's)
- ✧ Notebooks, Desktops, and Servers
- ✧ Portable Instrumentation
- ✧ Pagers
- ✧ Microprocessor based equipment



PIN Configuration

PROTECTION SOLUTION TO MEET

- ✧ IEC61000-4-2 (ESD) $\pm 30\text{kV}$ (air), $\pm 30\text{kV}$ (contact)

MECHANICAL CHARACTERISTICS

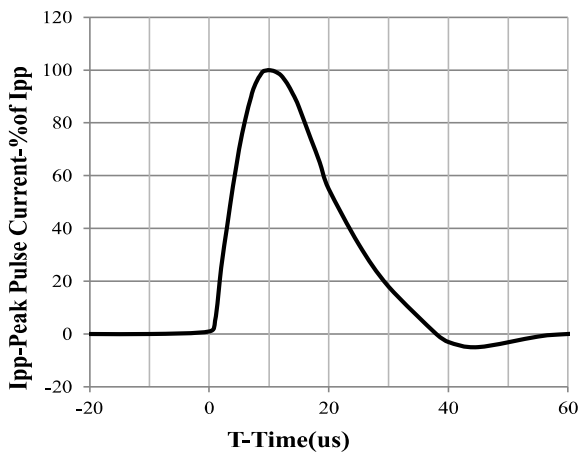
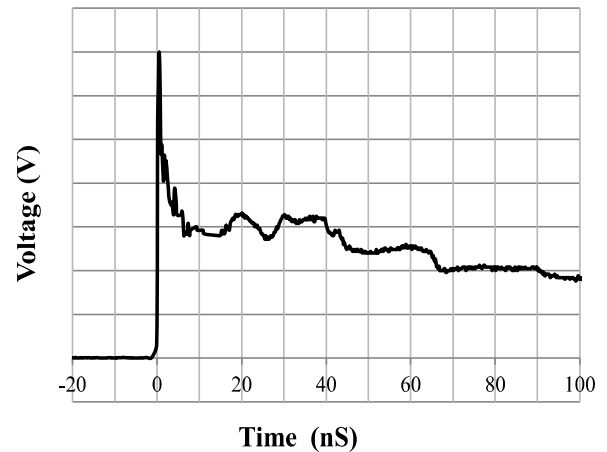
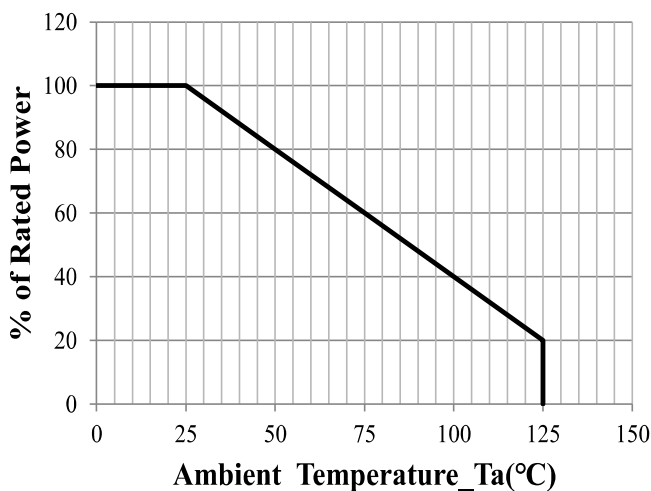
- ✧ Package SOD-323
- ✧ Molding Compound Flammability Rating : UL 94V-O
- ✧ Quantity Per Reel : 3,000pcs
- ✧ Lead Finish : Lead Free
- ✧ Marking code: 2H

ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$, RH=45%-75%, unless otherwise noted)

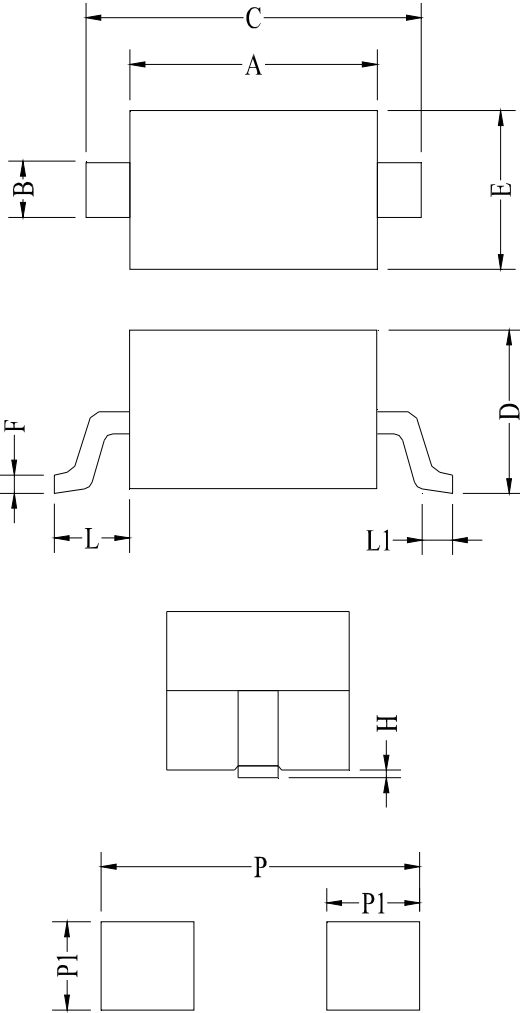
Parameter	Symbol	Value	Unit
Storage temperature range	T_{stg}	-55 to +150	$^\circ\text{C}$
Operating junction temperature range	T_j	-55 to +125	$^\circ\text{C}$
Lead Soldering Temperature	T_L	260 (10 sec.)	$^\circ\text{C}$
Peak pulse power dissipation on 8/20 μs waveform	P_{PP}	350	W
ESD per IEC 61000-4-2 (Air)	V_{ESD}	+/- 30	kV
ESD per IEC 61000-4-2 (Contact)		+/- 30	

ELECTRICAL CHARACTERISTICS ($T_A=25^{\circ}\text{C}$)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Reverse Working Voltage	V_R				24	V
Reverse Breakdown Voltage	V_{BR}	$I_T = 1\text{mA}$	26.7			V
Reverse Leakage Current	I_R	$V_R = 24\text{V}$			1	μA
Peak Pulse Current	I_{pp}	$t_p = 8/20\mu\text{s}$			7	A
Clamping Voltage	V_C	$I_{PP} = 1\text{A}, t_p = 8/20\mu\text{s}$			43	V
		$I_{PP} = 7\text{A}, t_p = 8/20\mu\text{s}$			52	V
Junction Capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$			50	pF

RATINGS AND V-I CHARACTERISTICS CURVES ($T_A=25^{\circ}\text{C}$, unless otherwise noted)

8 / 20us Pulse Waveform

IEC61000-4-2 Pulse Waveform

Power Derating Curve

PACKAGE MECHANICAL DATA



Symbol	Millimeter		Inches	
	Min	Max	Min	Max
A	1.60	1.80	0.063	0.071
B	0.25	0.35	0.010	0.014
C	2.50	2.70	0.098	0.106
D	0.00	1.00	0.000	0.039
E	1.20	1.40	0.047	0.055
F	0.08	0.15	0.003	0.006
L	0.475REF		0.019REF	
L1	0.25	0.40	0.010	0.016
H	0.00	0.10	0.000	0.004
P	3.00		0.118	
P1	0.80		0.031	

Land Pattern